

Docket No.: P2002,0075



I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as First Class mail in an envelope addressed to the Assistant Commissioner for Patents, Washington, D.C. 20231.

By: Markus Noll Date: March 12, 2002

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Inventor : Barbara Vasquez et al
Appl. No. : 10/062,942
Filed : January 31, 2002
Title : Method of Applying a Bottom Surface Protective Coating to a
Wafer, and Wafer Dicing Method

LETTER TO THE OFFICIAL DRAFTSMAN

Hon. Commissioner of Patents and Trademarks,
Washington, D.C. 20231

Sir:

Attached please find one (1) sheet of drawings in the above-identified application.

Please charge any fees due to Deposit Account No. 12-1099 of Lerner and Greenberg, P.A.

Respectfully submitted,

Markus Noll
For Applicant(s)

MARKUS NOLFF
REG. NO. 37,006

Date: March 12, 2002

Lerner and Greenberg, P.A.
Post Office Box 2480
Hollywood, FL 33022-2480
Tel: (954) 925-1100
Fax: (954) 925-1101

/sc